NSN 5962-01-274-2680

Memory Microcircuit - Page 1 of 1

Fiig: A458a0



View Online at https://aerobasegroup.com/nsn/5962-01-274-2680 **Body Length:** Between 0.554 inches and 0.572 inches **Body Width:** Between 0.554 inches and 0.572 inches **Body Height:** Between 0.055 inches and 0.090 inches **Maximum Power Dissipation Rating:** 1.0 watts **Operating Tempurature Range:** -55.0/+125.0 degrees celsius Storage Tempurature Range: -65.0/+150.0 degrees celsius **Features Provided:** Electrostatic sensitive and hermetically sealed and w/enable **Inclosure Material:** Ceramic or metal **Inclosure Configuration:** Leadless flat pack **Output Logic Form:** Complementary-metal oxide-semiconductor logic **Input Circuit Pattern:** 31 input **Terminal Surface Treatment:** Solder Voltage Rating And Type Per Characteristic: 7.0 volts power source **Memory Device Type:** Rom **Test Data Document:** 96906-mil-std-883 standard (includes industry or association standards, individual manufactureer standards, etc.). **Terminal Type And Quantity:** 48 leadless Shelf Life: N/a **Unit Of Measure: Demilitarization:** Yes - demil/mli